

Technology & Industry Alliances

Available Technologies

chnologies Contact Us

Request Information

Nitride Based Ultraviolet LED with an Ultraviolet Transparent Contact

Tech ID: 32271 / UC Case 2021-567-0

BACKGROUND

In conventional UVLED nitride devices, a metal mirror is often used as an electrical contact and requires the incorporation of other metals in order to obtain a low resistance electrical contact with the semiconductor material. These additional metals, however, are not transparent to emitted photons which causes a significant decrease in device efficiency. Although dielectric mirrors provide a potential alternative, their poor electrical properties are not suitable for high efficiency devices.

DESCRIPTION

Researchers at the University of California, Santa Barbara have developed a nitride based UVLED with an ultraviolet transparent contact (UVTC) that is an alloy composition of (Ga, Al, In, B)O semiconductors, such as Ga₂O₃. The n-type, p-type and UVTC regions are all transparent to UV light and minimize internal reflections within the UVLED by eliminating mirrors and/or mirrored surfaces. As a result, the UVLED output is drastically increased via the minimization of light re-absorption. Therefore, the improved light emission efficiency of UVLEDs enables the expansion of ultraviolet semiconductor device applications into a variety of commercial products.

ADVANTAGES

- Increased light efficiency
- Expands UVLED applications

APPLICATIONS

- ▶ UVLEDs
- ▶ LEDs
- Micro-LEDs

PATENT STATUS

| Country | Туре | Number | Dated | Case |
|--------------------------|-----------------------|-------------|------------|----------|
| United States Of America | Published Application | 20230420617 | 12/28/2023 | 2021-567 |

Permalink

CONTACT

Pasquale S. Ferrari ferrari@tia.ucsb.edu tel: .

INVENTORS

- DenBaars, Steven P.
- Iza, Michael
- Nakamura, Shuji
- Wong, Matthew S.

OTHER INFORMATION

KEYWORDS UVLED, LED, micro-LED, UVTC, transparent, ultraviolet transparent contact

CATEGORIZED AS

 Energy
Lighting
Semiconductors
Design and Fabrication
RELATED CASES
2021-567-0

- ► Vertical Cavity Surface-Emitting Lasers with Continuous Wave Operation
- Eliminating Misfit Dislocations with In-Situ Compliant Substrate Formation
- ▶ III-Nitride-Based Vertical Cavity Surface Emitting Laser (VCSEL) with a Dielectric P-Side Lens
- Enhanced Light Extraction LED with a Tunnel Junction Contact Wafer Bonded to a Conductive Oxide
- Ultraviolet Laser Diode on Nano-Porous AlGaN template
- Improved Reliability & Enhanced Performance of III-Nitride Tunnel Junction Optoelectronic Devices
- ▶ (In,Ga,AI)N Optoelectronic Devices with Thicker Active Layers for Improved Performance
- ▶ Thermally Stable, Laser-Driven White Lighting Device
- Methods for Fabricating III-Nitride Tunnel Junction Devices
- Contact Architectures for Tunnel Junction Devices
- III-Nitride Tunnel Junction LED with High Wall Plug Efficiency
- ▶ Novel Multilayer Structure for High-Efficiency UV and Far-UV Light-Emitting Devices
- A Method To Lift-Off Nitride Materials With Electrochemical Etch
- High-Intensity Solid State White Laser Diode
- ▶ High-Efficiency and High-Power III-Nitride Devices Grown on or Above a Strain Relaxed Template
- ▶ III-Nitride Based VCSEL with Curved Mirror on P-Side of the Aperture

University of California, Santa Barbara Office of Technology & Industry Alliances 342 Lagoon Road, ,Santa Barbara,CA 93106-2055 | https://www.tia.ucsb.edu Tel: 805-893-2073 | Fax: 805.893.5236 | padilla@tia.ucsb.edu in

Y

© 2021 - 2023, The Regents of the University of California Terms of use Privacy Notice